

National Semiconductor

# CP3SP33 Connectivity Processor with Cache, DSP, and Bluetooth<sup>®</sup>, USB, and Dual CAN Interfaces

#### 1.0 **General Description**

The CP3SP33 connectivity processor combines high performance with the massive integration needed for embedded Bluetooth applications. A powerful RISC core with 4Kbyte instruction cache and a Teak® DSP coprocessor provides high computing bandwidth, DMA-driven hardware communications peripherals provide high I/O bandwidth, and an external bus provides system expandability.

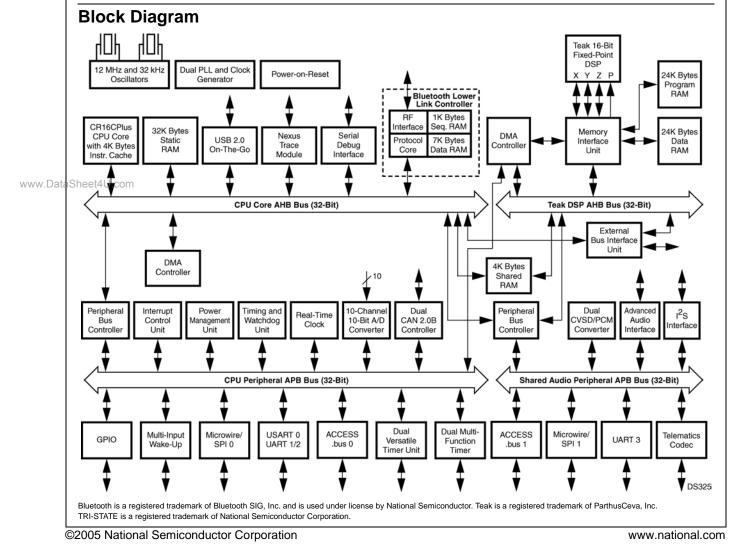
On-chip communications peripherals include: Bluetooth Lower Link Controller, Universal Serial Bus (2.0) OTG node and host controller, dual CAN, dual Microwire/Plus/SPI, dual ACCESS.bus, quad UART, 10-bit A/D converter, and telematics/audio codec. Additional on-chip peripherals include DMA controller, dual CVSD/PCM conversion module, I<sup>2</sup>S and AAI digital audio bus interfaces, Timing and Watchdog Unit, dual Versatile Timer Unit, dual Multi-Function Timer, and Multi-Input Wake-Up (MIWU) unit.

In addition to providing the features needed for the next generation of embedded Bluetooth products, the CP3SP33 is backed up by the software resources that designers need for rapid time-to-market, including an operating system, Bluetooth protocol stack implementation, peripheral drivers, reference designs, and an integrated development environment. Combined with an external program memory and a Bluetooth radio transceiver such as National's LMX5252, the CP3SP33 provides a complete Bluetooth system solution.

PRELIMINARY

September 2005

National Semiconductor offers a complete and industryproven application development environment for CP3SP33 applications, including the IAR Embedded Workbench, iSYSTEM winIDEA and iC3000 Active Emulator, Bluetooth Development Board, Bluetooth protocol stack, and application examples.



#### 2.0 **Features**

### **CPU Features**

- Fully static RISC processor core, capable of operating from 0 to 96 MHz with zero wait/hold state
- Minimum 10.4 ns instruction cycle time with a 96-MHz internal clock frequency, based on a 12-MHz external input
- 4K-byte, 4-way set-associative instruction cache
- 69 independently vectored peripheral interrupts

### **DSP** Features

- Capable of operating up to 96 MHz
- 16-bit fixed-point arithmetic, dual-MAC architecture
- 32-bit interface to 4K-byte RAM shared with CPU
- 32-bit external bus interface
- Bus master interface to audio peripherals and I/O

### Memory

- 4K bytes CPU instruction cache
- 32K bytes CPU data RAM
- 4K bytes CPU/DSP shared RAM
- 24K bytes DSP program RAM
- 24K bytes DSP data RAM
- 8K bytes Bluetooth sequencer and data RAM
- Addresses up to 32M bytes of external memory

### Broad Range of Hardware Communications Peripherals

- Bluetooth Lower Link Controller (LLC) including a shared 7K byte Bluetooth data RAM and 1K byte Bluetooth Sequencer RAM
- Universal Serial Bus (USB) 2.0 On-The-Go
- Audio/telematics codec with dual ADC inputs and highquality stereo DAC output
- Two CAN interfaces with 15 message buffers conforming to CAN specification 2.0B active
- Two ACCESS.bus serial bus interfaces (I<sup>2</sup>C compatible)
- Two 8/16-bit SPI, Microwire/Plus serial interfaces
- I<sup>2</sup>S digital audio bus interface
- Four Universal Asynchronous Receiver/Transmitter

www.DataShee(UART) channels, one channel has USART capability

- Advanced Audio Interface (AAI) to connect to external 8/ 13-bit PCM Codecs as well as to ISDN-Controllers through the IOM-2 interface (slave only)
- Two CVSD/PCM converters, for supporting two bidirectional audio connections

#### External Bus Interface Shared Between CPU and DSP

- 16/32-bit data bus
- 23-bit address bus
- 3 programmable chip select outputs
- Up to 32M bytes external memory
- 8-level write buffer

#### **General-Purpose Hardware Peripherals**

- 10-channel, 10-bit A/D Converter (ADC)
- 16-channel DMA controller
- Dual 16-bit Multi-Function Timer (MFT)
- Dual Versatile Timer Units (VTU), each with four independent timers
- Timing and Watchdog Unit

#### **Extensive Power and Clock Management Support**

- Two Phase Locked Loops (PLL) for synthesizing independent system and audio peripheral clocks
- Two independent oscillators for Active mode (12 MHz) and Power Save mode (32.768 kHz) clocks
- Low-power modes (Power Save, Idle, and Halt) for slow-ing or stopping clocks to optimize power consumption while meeting application needs

#### Flexible I/O

- Up to 64 general-purpose I/O pins (shared with on-chip peripheral I/O)
- Programmable I/O pin characteristics: TRI-STATE output, push-pull output, weak pullup/pulldown input, highimpedance input, high-speed drive capability
- Schmitt triggers on general-purpose inputs
- Multi-Input Wake-Up (MIWU) capability

#### **Power Supply**

- I/O port operation at 3.0–3.3V
- Core logic operation at 1.8V
- On-chip power-on reset

#### **Temperature Range**

■ -40°C to +85°C (Industrial)

#### Packages

FBGA-224, FBGA-144

#### **Complete Development Environment**

- Pre-integrated hardware and software support for rapid prototyping and production
- Multi-file C source editor, source debugger, and project manager
- Comprehensive, integrated, one-stop technical support

#### **Bluetooth Protocol Stack**

- Applications can interface to the high-level protocols or directly to the low-level Host Controller Interface (HCI)
- Transport layer support allows HCI command-based interface over UART port
- Baseband (Link Controller) hardware minimizes the bandwidth demand on the CPU
- Link Manager (LM)
- Logical Link Control and Adaptation Protocol (L2CAP)
- Service Discovery Protocol (SDP)
- RFCOMM Serial Port Emulation Protocol
- All packet types, piconet, and scatternet functionality

#### **CP3SP33 Connectivity Processor Selection Guide**

NSID	Speed (MHz)	Temp. Range			I/Os	Package Type
CP3SP33SMS	96	-40° to +85°C			64	FBGA-224
CP3SP33SMR	96	-40° to +85°C			36	FBGA-144

www.DataSheet4U.com

## 3.0 Device Overview

The CP3SP33 connectivity processor is an advanced microcomputer with system timing, interrupt logic, instruction cache, data memory, and I/O ports included on-chip, making it well-suited to a wide range of embedded applications. The block diagram on page 1 shows the major on-chip components of the CP3SP33.

### 3.1 CR16CPLUS CPU CORE

The CP3SP33 contains a CR16CPlus CPU core. This core improves upon the performance of previous CP3000 devices by adding a 4-Kbyte instruction cache and doubling the CPU core data bus bandwidth. The cache greatly reduces instruction-fetch bandwidth on the 32-bit system bus, which leaves more bus bandwidth available for DMA-based I/O. The cache moves the average execution rate closer to the peak rate of one instruction per clock cycle, especially when executing from off-chip program memory. The DMA controller provides efficient sharing of the CPU core bus between the CPU and high-bandwidth peripherals such as wired and wireless communication interfaces.

For information on the instruction set architecture, please refer to the *CR16C Programmer's Reference Manual* (document number 424521772-101, which may be downloaded from National's web site at http://www.national.com).

### 3.2 TEAK DSP CORE

The Teak 16-bit fixed-point DSP core is designed for lowpower, high-speed digital signal processing applications, including acoustic echo cancellation, noise reduction, and MP3/WMA decoding. It features a four-bus, dual-MAC, enhanced Harvard architecture. The DSP has 24K bytes of dedicated program RAM, 24K bytes of data RAM, and a 4Kbyte RAM shared with the CPU. The DSP has a bus master interface to the 4K-byte shared RAM and an external memory bus. It also has a bus master interface to a shared audio peripheral bus. The DSP is slave on the CPU peripheral bus, for downloading software to the program RAM.

www.DataSiThedDSPihas its own DMA controller for I/O and memory access.

### 3.3 AMBA BUS ARCHITECTURE

The CPU and DSP core buses implement AMBA-compatible AHB high-performance 32-bit buses with bursting and split transactions. The CPU peripheral bus and CPU/DSP shared audio peripheral bus implement AMBA-compatible 32-bit APB buses. The CPU and DSP buses operate at independent rates up to 96 MHz. The APB buses operate at a rate which is a factor of 1, 2, or 4 slower than the CPU AHB bus.

### 3.4 EXTERNAL BUS INTERFACE UNIT

The External Bus Interface Unit (EBIU) provides programmable timing, memory type, base address, size, and bus width (8, 16, or 32 bits) for three regions of up to 32M bytes. An 8-level write buffer releases the bus master to continue execution without waiting for write cycles to complete.

### 3.5 MEMORY

The CP3SP33 devices support a uniform linear address space. Three types of on-chip memory occupy specific regions within this address space, along with any external memory:

- 32K bytes of CPU RAM
- 4K bytes of CPU/DSP shared RAM
- 8K bytes of Bluetooth sequencer and data RAM
- Up to 32M bytes of external memory

A non-volatile external program memory is used to store the application program, Bluetooth protocol stack, and real-time operating system.

The 32K bytes of CPU RAM are used for temporary storage of data and for the program stack and interrupt stack. Read and write operations can be byte-wide or word-wide, depending on the instruction executed by the CPU.

### 3.6 BLUETOOTH LLC

The integrated hardware Bluetooth Lower Link Controller (LLC) complies to the Bluetooth Specification Version 1.2 and integrates the following functions:

- 7K-byte dedicated Bluetooth data RAM
- 1K-byte dedicated Bluetooth sequencer RAM
- Support of all Bluetooth 1.2 packet types and extended Synchronous Connection-Oriented (eSCO) links
- Support for fast frequency hopping of 1600 hops/s
- Access code correlation and slot timing recovery circuit
- Power Management Control Logic
- BlueRF-compatible interface (mode 2/3) to connect with National's LMX5252 and other RF transceiver chips

### 3.7 USB

The full-speed Universal Serial Bus (USB) node and host controller is compatible with USB Specification 2.0 and USB On-The-Go. It integrates the required USB transceiver, the Serial Interface Engine (SIE), and USB endpoint FIFOs. A total of seven endpoint pipes are supported: one bidirectional pipe for the mandatory control EP0 and an additional six pipes for unidirectional endpoints to support USB interrupt, bulk, and isochronous data transfers.

The on-chip USB transceiver features an integrated pullup resistor on the D+ line to UVCC. This pullup resistor can be switched in or out by the USB VBUS sense input (VBUS), which eliminates the need for external components.

### 3.8 CAN INTERFACE

The two CAN modules support Full CAN 2.0B class, CAN serial bus interfaces for applications that require a high-speed (up to 1 Mbits per second) or a low-speed interface with CAN bus master capability. The data transfer between CAN and the CPU is established by 15 memory-mapped message buffers, which can be individually configured as receive or transmit buffers. An incoming message is filtered by two masks, one for the first 14 message buffers and another one for the 15th message buffer to provide a basic CAN path. A priority decoder allows any buffer to have the highest or lowest transmit priority. Remote transmission requests can be processed automatically by automatic reconfiguration to a receiver after transmission or by automated

3

P3SP33

www.Data

transmit scheduling upon reception. In addition, a 16-bit **3.13** time stamp counter supports real-time applications.

The CAN modules allow single-cycle byte or word read/ write access. A set of diagnostic features (such as loopback, listen only, and error identification) support the development with the CAN modules and provide a sophisticated error management tool.

The CAN receivers can trigger a wake-up condition out of low-power modes through the Multi-Input Wake-Up unit.

### 3.9 AUDIO/TELEMATICS CODEC

The on-chip codec is designed for voice input and stereo audio playback. It includes dual mono ADC channels operating at a sample rate of 8-24 kHz (125x oversampling clock required). A stereo DAC operates at selected sample rates from a 125x or 128x oversampling clock, driving two configurable, gain-programmable differential line driver outputs. The DAC features click and pop reduction circuit, zerocross detector circuit, tone/compensation filter, sidetone injection from ADC, and internal power management circuit. The ADCs accept differential or single-ended analog microphone inputs. The DAC employs fully differential signalling for high PSRR and low crosstalk. DMA transfers are supported to allow for fast CPU-independent receive and transmit.

### 3.10 CVSD/PCM CONVERSION MODULES

The two CVSD/PCM modules perform conversion between CVSD data and PCM data, in which the CVSD encoding is as defined in the Bluetooth specification and the PCM data can be 8-bit  $\mu$ -Law, 8-bit A-Law, or 13-bit to 16-bit Linear.

### 3.11 I<sup>2</sup>S DIGITAL AUDIO BUS

The Inter-IC Sound (I<sup>2</sup>S) interface is a synchronous serial interface intended for the transfer of digital audio data. The I<sup>2</sup>S interface can be configured as a master or a slave, and it supports all three common data formats: I<sup>2</sup>S-mode, left-justified, and right-justified. It has programmable word length from 8 to 32 bits and programmable valid data resolution from 8 to 24 bits.

#### 3.12 ADVANCED AUDIO INTERFACE

The Advanced Audio Interface (AAI) provides a serial synchronous, full-duplex interface to codecs and similar serial devices. Transmit and receive paths operate asynchronously with respect to each other. Each path uses three signals for communication: shift clock, frame synchronization, and data.

When the receiver and transmitter use external shift clocks and frame sync signals, the interface operates in its asynchronous mode. Alternatively, the transmit and receive path can share the same shift clock and frame sync signals for synchronous mode operation.

### 3.13 ANALOG TO DIGITAL CONVERTER

This device contains a 10-channel, multiplexed input, successive approximation, 10-bit Analog-to-Digital Converter. It supports both single-ended and differential modes of operation.

The integrated 10-bit ADC provides the following features:

- 10-channel, multiplexed input
- 5 differential channels
- Single-ended and differential external filtering capability
- 12-bit resolution; 10-bit accuracy
- Sign bit

- 10-microsecond conversion time
  - External start trigger
- Programmable start delay after start trigger
- Poll or interrupt on conversion completion

The ADC provides several options for the voltage reference source. The positive reference can be ADVCC (internal), VREF, ADC0, or ADC1. The negative reference can be AD-VCC (internal), ADC2, or ADC3.

Two specific analog channel selection modes are supported. These are as follows:

- Allow any specific channel to be selected at one time. The A/D Converter performs the specific conversion requested and stops.
- Allow any differential channel pair to be selected at one time. The A/D Converter performs the specific differential conversion requested and stops.

In both single-ended and differential modes, there is the capability to connect the analog multiplexer output and A/D converter input to external pins. This provides the ability to externally connect a common filter/signal conditioning circuit for the A/D Converter.

#### 3.14 QUAD UART

Four UART modules support a wide range of programmable baud rates and data formats, parity generation, and several error detection schemes. The baud rate is generated onchip, under software control. All UART modules support DMA and hardware flow control. One module has USART capability (synchronous mode) at speeds up to 921.6 kbaud. The UARTs offer a wake-up condition from the lowpower modes using the Multi-Input Wake-Up module.

### 3.15 MICROWIRE/SPI

The two Microwire/SPI (MWSPI) interface modules support synchronous serial communications with other devices that conform to Microwire or Serial Peripheral Interface (SPI) specifications. It supports 8-bit and 16-bit data transfers.

The Microwire interfaces allows several devices to communicate over a single system consisting of four wires: serial in, serial out, shift clock, and slave enable. At any given time, the Microwire interfaces operate as a master or a slave. The Microwire interfaces supports the full set of slave select for multi-slave implementation.

In master mode, the shift clock is generated on-chip under software control. In slave mode, a wake-up out of a lowpower mode may be triggered using the Multi-Input Wake-Up module.

P3SP33

## 3.16 DUAL ACCESS.BUS INTERFACE

The two ACCESS.bus (ACB) interface modules support a two-wire serial interface compatible with the ACCESS.bus physical layer. It is also compatible with Intel's System Management Bus (SMBus) and Philips'  $I^2C$  bus. The ACB modules can be configured as a bus master or slave, and they can maintain bidirectional communications with both multiple master and slave devices.

The ACCESS.bus receivers can trigger a wake-up condition out of the low-power modes through the Multi-Input Wake-Up module.

### 3.17 DUAL MULTI-FUNCTION TIMER

The two Multi-Function Timer (MFT) modules each contain a pair of 16-bit timer/counter registers. Each timer/counter unit can be configured to operate in any of the following modes:

- Processor-Independent Pulse Width Modulation (PWM) mode: Generates pulses of a specified width and duty cycle and provides a general-purpose timer/ counter.
- Dual Input Capture mode: Measures the elapsed time between occurrences of external event and provides a general-purpose timer/counter.
- Dual Independent Timer mode: Generates system timing signals or counts occurrences of external events.
- Single Input Capture and Single Timer mode: Provides one external event counter and one system timer.

### 3.18 VERSATILE TIMER UNITS

The two Versatile Timer Unit (VTU) modules each contain four independent timer subsystems, which operate as a dual 8-bit PWM configuration, a single 16-bit PWM timer, or a 16-bit counter with two input capture channels. Each of the timer subsystems offer an 8-bit clock prescaler to accommodate a wide range of frequencies.

### www.DataSheetaU.com

The Timing and Watchdog Module (TWM) contains a Real-Time timer and a Watchdog unit. The Real-Time Clock Timing function can be used to generate periodic real-time based system interrupts. The timer output is one of 16 inputs to the Multi-Input Wake-Up module which can be used to exit from a low-power mode. The Watchdog unit is designed to detect the application program getting stuck in an infinite loop resulting in loss of program control or "runaway" programs. When the watchdog triggers, it resets the device. The TWM is clocked by the low-speed Slow Clock.

### 3.20 MULTI-INPUT WAKE-UP

The Multi-Input Wake-Up (MIWU) feature is used to return (wake-up) the device from low-power modes to the active mode. The 64-channel MIWU unit receives wake-up signals from various internal and external sources. In addition to the wake-up function, the MIWU unit can generate up to eight interrupt requests. Each MIWU channel can be individually programmed to activate one of the interrupt requests.

### 3.21 POWER MANAGEMENT

The Power Management Module (PMM) improves the efficiency of the device by changing the operating mode and power consumption to match the required level of activity.

The device can operate in any of four power modes:

- *Active:* The device operates at full speed using the high-frequency clock. All device functions are fully operational.
- Power Save: The device operates at reduced speed using the Slow Clock. The CPU and some modules can continue to operate at this low speed.
- Idle: The device is inactive except for the Power Management Module and Timing and Watchdog Module, which continue to operate using the Slow Clock.
- Halt: The device is inactive but still retains its internal state (RAM and register contents).

The PMM provides a mechanism to handle Bluetooth-specific power management modes, for optimizing power consumption during special Bluetooth states, like Park, Page Scan, Inquiry Scan, etc.

### 3.22 INPUT/OUTPUT PORTS

The device has 64 software-configurable I/O pins (36 in the FBGA-144 package), organized into four ports called Port E, Port F, Port G, and Port H. Each pin can be configured to operate as a general-purpose input or general-purpose output. In addition, many I/O pins can be configured to operate as inputs or outputs for on-chip peripheral modules such as the UARTs or timers.

The I/O pin characteristics are fully programmable. Each pin can be configured to operate as a TRI-STATE output, pushpull output, weak pullup/pulldown input, high-speed drive, or high-impedance input.

### 3.23 CLOCK AND RESET MODULE

The Clock and Reset module generates a 12-MHz Main Clock from an external crystal network or external clock input. Main Clock may be used as a reference clock for two PLL-based clock multipliers available for generating higherspeed clocks.

Most modules operate from clocks derived from Main Clock or a PLL clock. Modules on the CPU core AHB bus operate from HCLK Clock, while modules on the peripheral APB buses operate from PCLK Clock. PCLK Clock is generated by dividing HCLK Clock by 1, 2, or 4. Some peripheral modules may use one of several auxiliary clocks, which also are derived from Main Clock or a PLL clock using 12-bit programmable prescalers.

In Power-Save mode, HCLK Clock is driven by Slow Clock, which is typically a 32.768 kHz signal generated from an external clock network or a prescaled Main Clock may be used to eliminate the 32.768 kHz crystal network, for the most cost-sensitive applications. In the most power-sensitive applications, operation from an external 32.768 kHz crystal network allows the high-frequency oscillator and PLLs to be shut down. In addition, the Clock and Reset module generates the device reset by using reset input signals coming from an external reset, the watchdog timer, or the SDI debugging interface. A power-on reset (POR) circuit eliminates the need for an external RC network. The POR circuit generates an internal reset of sufficient length if the power supply rise time specification is met.

#### 3.24 DMA CONTROLLER

The Direct Memory Access Controller (DMAC) can speed up data transfer between memory and I/O devices or between two regions of memory, as compared to data transfers performed directly by the CPU. Cycle stealing allows the CPU and the DMAC to interleave access to the CPU core bus for greater utilization of the available bandwidth. The following on-chip modules can assert a DMA request to the DMA controller:

- USART 0 (2 request channels)
- UART 1/2/3 (6 request channels)
- Advanced Audio Interface (6 request channels)
- CVSD/PCM Converter 0/1 (8 request channels)
- Microwire/SPI 0/1 (4 request channels)
- ACCESS.bus 0/1 (2 request channels)
- Codec (4 request channels)
- I<sup>2</sup>S Interface (4 request channels)

The DSP has its own DMA controller which can be configured to accept DMA requests from peripherals on the shared audio peripheral APB bus. The USB controller also has its own DMA controller, which operates on the CPU core bus.

### 3.25 SERIAL DEBUG INTERFACE

The Serial Debug Interface module (SDI module) provides a JTAG-based serial link to an external debugger, for example running on a PC. In addition, the SDI module integrates an on-chip debug module, which allows the user to set up to eight hardware breakpoints on instruction execution and data transfer. The SDI module can act as a CPU bus master to access all memory-mapped resources, such as RAM and peripherals. Therefore it also allows for fast program code download using the JTAG interface.

#### 3.26 DEVELOPMENT SUPPORT

In addition to providing the features needed for the next generation of embedded Bluetooth products, the CP3SP33 devices are backed up by the software resources that designers need for rapid product development, including an operating system, Bluetooth protocol stack implementation, peripheral drivers, reference designs, and an integrated development environment. Combined with National's LMX5251 Bluetooth radio transceiver, the CP3SP33 devices provide a total Bluetooth system solution.

National Semiconductor offers a complete and industryproven application development environment for CP3SP33 applications, including the IAR Embedded Workbench, iSYSTEM winIDEA and iC3000 Active Emulator, Bluetooth Development Board, Bluetooth Protocol Stack, and Application Software. See your National Semiconductor sales representative for current information on availability and features of emulation equipment and evaluation boards.

ataSheet4U.com

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### BANNED SUBSTANCE COMPLIANCE

National Semiconductor certifies that the products and packing materials meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.

Leadfree products are RoHS compliant.

R

National Semiconductor Corporation	National Semic Europe			
Tel: 1-800-272-9959	Fax:	+4		
Fax: 1-800-737-7018	Email:	europ		
Email: support@nsc.com	Deutsch Tel:	+		
	English Tel:	+-		
nal.com	Francais Tel:	+		

 National Semiconductor Asia Pacific Customer Response Group Tel: 65-254-4466 Fax: 65-250-4466 Email: ap.support@nsc.com National Semiconductor Japan Ltd. Tel: 81-3-5639-7560 Fax: 81-3-5639-7507

www.national.com

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.